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Thyristor High Voltage Surface Mount Phase Control SCR, 10 A



PRIMARY CHARACTERISTICS							
I _{T(AV)} 6.5 A							
V_{DRM}/V_{RRM}	800 V						
V _{TM}	< 1.15 V						
I _{GT}	15 mA						
T_J	-40 to +125 °C						
Package	D ² PAK (TO-263AB)						
Circuit configuration	Single SCR						

FEATURES

 Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C



 Designed and qualified according JEDEC®-JESD 47

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Input rectification (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-10TTS08S-M3 high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS									
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS									
NEMA FR-4 or G-10 glass fabric-based epoxy with 4 oz. (140 μm) copper	2.5	3.5							
Aluminum IMS, R _{thCA} = 15 °C/W	6.3	9.5	A						
Aluminum IMS with heatsink, R _{thCA} = 5 °C/W	14.0	18.5							

Note

T_A = 55 °C, T_J = 125 °C, footprint 300 mm²

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	VALUES	UNITS						
I _{T(AV)}	Sinusoidal waveform	6.5	۸						
I _{RMS}		10	Α						
V _{RRM} /V _{DRM}		800	V						
I _{TSM}		110	A						
V _T	6.5 A, T _J = 25 °C	1.15	V						
dV/dt		150	V/µs						
dl/dt		100	A/µs						
T _J	Range	-40 to +125	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA						
VS-10TTS08S-M3	800	800	1.0						





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ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS				
Maximum average on-state current	I _{T(AV)}	T 110 °C 100° conduc	T 110.00 1000 1 11 1 11					
Maximum RMS on-state current	I _{T(RMS)}	$T_C = 112 ^{\circ}\text{C}, 180^{\circ} \text{ conduc}$	tion hall sine wave	10	Α			
Maximum peak, one-cycle,	1	10 ms sine pulse, rated V _F	RRM applied, T _J = 125 °C	95	A			
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no volta	ge reapplied, T _J = 125 °C	110				
Maximum 12t for fusing	I ² t	10 ms sine pulse, rated V _F	RRM applied, T _J = 125 °C	45	A 2 -			
Maximum I ² t for fusing	1-1	10 ms sine pulse, no volta	64	A ² s				
Maximum I ² √t for fusing	l²√t	t = 0.1 ms to 10 ms, no vo	640	A²√s				
Maximum on-state voltage drop	V_{TM}	6.5 A, T _J = 25 °C	1.15	V				
On-state slope resistance	r _t	T 405 00		17.3	mΩ			
Threshold voltage	V _{T(TO)}	T _J = 125 °C		0.85	V			
Maximum reverse and direct leakage current	1 /1	T _J = 25 °C	V voted V A/	0.05				
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	T _J = 125 °C	$V_R = \text{rated } V_{RRM} / V_{DRM}$	1.0				
Typical holding current	I _H	Anode supply = 6 V, resist $T_J = 25 ^{\circ}\text{C}$	30	mA				
Maximum latching current	ΙL	Anode supply = 6 V, resist	50					
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80^\circ$	T _J = T _J max., linear to 80 %, V _{DRM} = R _q - k = open					
Maximum rate of rise of turned-on current	dl/dt			100	A/μs			

TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum peak gate power	P _{GM}		8.0	W				
Maximum average gate power	P _{G(AV)}		2.0	VV				
Maximum peak positive gate current	+I _{GM}		1.5	Α				
Maximum peak negative gate voltage	-V _{GM}		10	V				
		Anode supply = 6 V, resistive load, T _J = -65 °C						
Maximum required DC gate current to trigger	I _{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	15	mA				
		Anode supply = 6 V, resistive load, T _J = 125 °C	10					
		Anode supply = 6 V, resistive load, T _J = - 65 °C	1.2					
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	1	V				
voltage to trigger		Anode supply = 6 V, resistive load, T _J = 125 °C	0.7	V				
Maximum DC gate voltage not to trigger	V_{GD}	T 105 °C V reted value	0.2					
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = rated value	0.1	mA				

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t _{gt}	T _J = 25 °C	0.8	
Typical reverse recovery time	t _{rr}	T _{.1} = 125 °C	3	μs
Typical turn-off time	t _q	1j=120 C	100	

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THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +125	°C					
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	1.5	°C/W					
Typical thermal resistance, junction to ambient (PCB mount)	R _{thJA} ⁽¹⁾		40	C/VV					
Approximate weight			2	g					
Approximate weight			0.07	oz.					
Marking device		Case style D ² PAK (TO-263AB)	10TTS	08S					

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 μm) copper 40 °C/W. For recommended footprint and soldering techniques refer to application note #AN-994

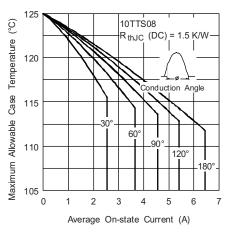


Fig. 1 - Current Rating Characteristics

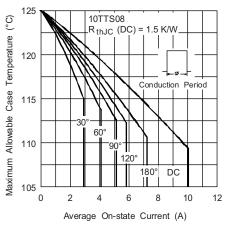


Fig. 2 - Current Rating Characteristics

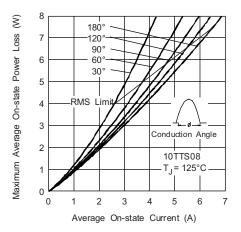


Fig. 3 - On-State Power Loss Characteristics

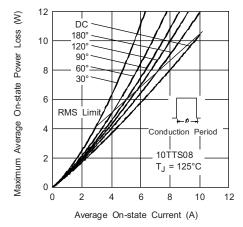


Fig. 4 - On-State Power Loss Characteristics

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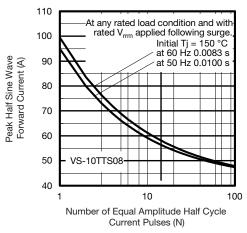


Fig. 5 - Maximum Non-Repetitive Surge Current

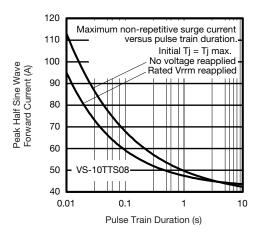


Fig. 6 - Maximum Non-Repetitive Surge Current

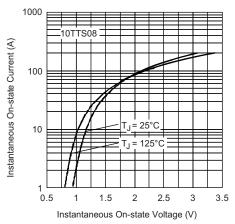


Fig. 7 - On-State Voltage Drop Characteristics

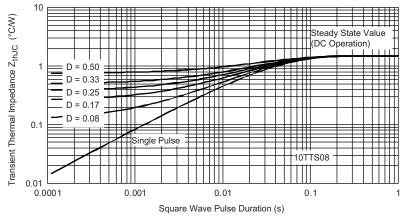


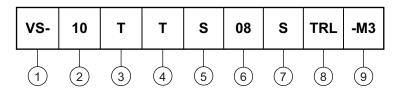
Fig. 8 - Thermal Impedance Z_{thJC} Characteristics



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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating, RMS value

3 - Circuit configuration:

T = single thyristor

4 - Package:

 $T = D^2PAK (TO-263AB)$

5 - Type of silicon:

S = converter grade

Voltage code x 100 = V_{RRM}

7 - S = surface mountable

Tape and reel option:

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

9 - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPT								
VS-10TTS08S-M3	50	1000	Antistatic plastic tubes					
VS-10TTS08STRR-M3	800	800	13" diameter reel					
VS-10TTS08STRL-M3	800	800	13" diameter reel					

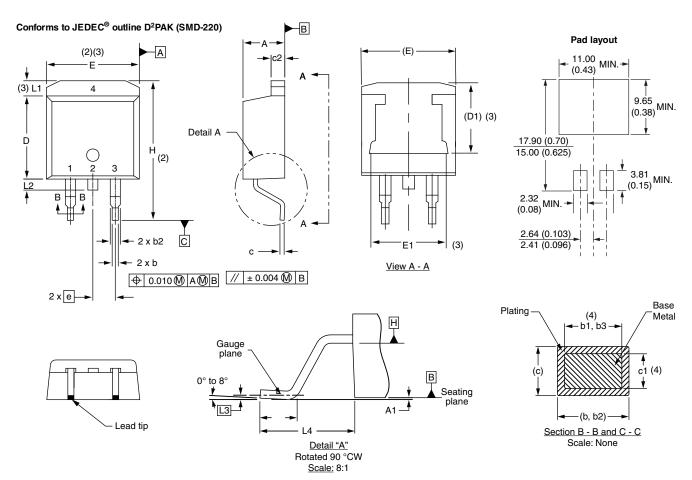
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?96164</u>					
Part marking information	www.vishay.com/doc?95444				
Packaging information	www.vishay.com/doc?96424				



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D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	HES	NOTES	NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

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